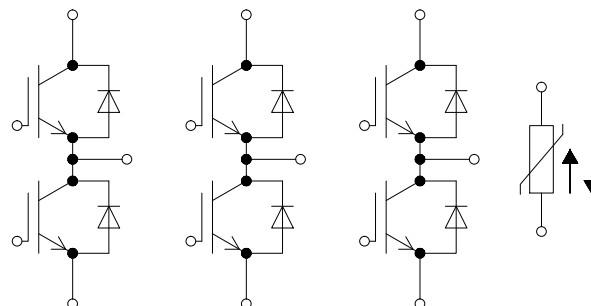


EconoPACK™+ Modul mit Trench/Feldstopp IGBT4 und Emitter Controlled HE Diode und PressFIT / bereits aufgetragenem Thermal Interface Material

EconoPACK™+ module with Trench/Fieldstop IGBT4 and Emitter Controlled HE diode and PressFIT / pre-applied Thermal Interface Material

Vorläufige Daten / Preliminary Data



$V_{CES} = 1200V$
 $I_{C\ nom} = 225A / I_{CRM} = 450A$

Typische Anwendungen

- Aufzugstechnik
- Hochleistungsumrichter
- Hybrid-Nutzfahrzeuge
- Motorantriebe
- USV-Systeme

Typical Applications

- Elevators
- High power converters
- Commercial Agriculture Vehicles
- Motor drives
- UPS systems

Elektrische Eigenschaften

- Hohe Kurzschlussrobustheit
- Sehr große Robustheit
- Trench IGBT 4
- $T_{vj\ op} = 150^{\circ}C$
- Hohe Stoßstromfestigkeit

Electrical Features

- High short-circuit capability
- Unbeatable robustness
- Trench IGBT 4
- $T_{vj\ op} = 150^{\circ}C$
- High surge current capability

Mechanische Eigenschaften

- Hohe mechanische Robustheit
- Integrierter NTC Temperatur Sensor
- PressFIT Verbindungstechnik
- RoHS konform
- Thermisches Interface Material bereits aufgetragen

Mechanical Features

- High mechanical robustness
- Integrated NTC temperature sensor
- PressFIT contact technology
- RoHS compliant
- Pre-applied Thermal Interface Material

Module Label Code

Barcode Code 128



DMX - Code



Content of the Code

Digit

| | |
|----------------------------|---------|
| Module Serial Number | 1 - 5 |
| Module Material Number | 6 - 11 |
| Production Order Number | 12 - 19 |
| Datecode (Production Year) | 20 - 21 |
| Datecode (Production Week) | 22 - 23 |

| | | |
|-----------------|---------------------------------|----------------------|
| prepared by: ZV | date of publication: 2016-07-29 | |
| approved by: KV | revision: V2.0 | UL approved (E83335) |



**Vorläufige Daten
Preliminary Data**

**IGBT, Wechselrichter / IGBT, Inverter
Höchstzulässige Werte / Maximum Rated Values**

| | | | | |
|--|---|--------------------|-------|---|
| Kollektor-Emitter-Sperrspannung Collector-emitter voltage | $T_{vj} = 25^{\circ}\text{C}$ | V_{CES} | 1200 | V |
| Kollektor-Dauergleichstrom Continuous DC collector current | $T_H = 80^{\circ}\text{C}, T_{vj\text{ max}} = 175^{\circ}\text{C}$ | $I_{C\text{ nom}}$ | 225 | A |
| Periodischer Kollektor-Spitzenstrom Repetitive peak collector current | $t_P = 1\text{ ms}$ | I_{CRM} | 450 | A |
| Gate-Emitter-Spitzenspannung Gate-emitter peak voltage | | V_{GES} | +/-20 | V |

Charakteristische Werte / Characteristic Values

| | | | min. | typ. | max. | | |
|--|--|---|---------------------|----------------------|------|-------------|---|
| Kollektor-Emitter-Sättigungsspannung Collector-emitter saturation voltage | $I_C = 225\text{ A}, V_{GE} = 15\text{ V}$ $I_C = 225\text{ A}, V_{GE} = 15\text{ V}$ $I_C = 225\text{ A}, V_{GE} = 15\text{ V}$ | $T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$ | $V_{CE\text{ sat}}$ | 1,85 2,10 2,15 | 2,15 | V V V | |
| Gate-Schwellenspannung Gate threshold voltage | $I_C = 7,80\text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25^{\circ}\text{C}$ | | V_{GEth} | 5,20 | 5,80 | 6,40 | V |
| Gateladung Gate charge | $V_{GE} = -15\text{ V} \dots +15\text{ V}$ | | Q_G | 1,55 | | | μC |
| Interner Gatewiderstand Internal gate resistor | $T_{vj} = 25^{\circ}\text{C}$ | | R_{Gint} | 3,3 | | | Ω |
| Eingangskapazität Input capacitance | $f = 1\text{ MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$ | | C_{ies} | 13,0 | | | nF |
| Rückwirkungskapazität Reverse transfer capacitance | $f = 1\text{ MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$ | | C_{res} | 0,705 | | | nF |
| Kollektor-Emitter-Reststrom Collector-emitter cut-off current | $V_{CE} = 1200\text{ V}, V_{GE} = 0\text{ V}, T_{vj} = 25^{\circ}\text{C}$ | | I_{CES} | | | 3,0 | mA |
| Gate-Emitter-Reststrom Gate-emitter leakage current | $V_{CE} = 0\text{ V}, V_{GE} = 20\text{ V}, T_{vj} = 25^{\circ}\text{C}$ | | I_{GES} | | | 400 | nA |
| Einschaltverzögerungszeit, induktive Last Turn-on delay time, inductive load | $I_C = 225\text{ A}, V_{CE} = 600\text{ V}$ $V_{GE} = \pm 15\text{ V}$ $R_{Gon} = 0,75\ \Omega$ | $T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$ | t_{don} | 0,17 0,18 0,19 | | | μs μs μs |
| Anstiegszeit, induktive Last Rise time, inductive load | $I_C = 225\text{ A}, V_{CE} = 600\text{ V}$ $V_{GE} = \pm 15\text{ V}$ $R_{Gon} = 0,75\ \Omega$ | $T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$ | t_r | 0,04 0,04 0,04 | | | μs μs μs |
| Abschaltverzögerungszeit, induktive Last Turn-off delay time, inductive load | $I_C = 225\text{ A}, V_{CE} = 600\text{ V}$ $V_{GE} = \pm 15\text{ V}$ $R_{Goff} = 0,75\ \Omega$ | $T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$ | t_{doff} | 0,34 0,45 0,47 | | | μs μs μs |
| Fallzeit, induktive Last Fall time, inductive load | $I_C = 225\text{ A}, V_{CE} = 600\text{ V}$ $V_{GE} = \pm 15\text{ V}$ $R_{Goff} = 0,75\ \Omega$ | $T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$ | t_f | 0,06 0,09 0,10 | | | μs μs μs |
| Einschaltverlustenergie pro Puls Turn-on energy loss per pulse | $I_C = 225\text{ A}, V_{CE} = 600\text{ V}, L_S = 35\text{ nH}$ $V_{GE} = \pm 15\text{ V}, di/dt = 5200\text{ A}/\mu\text{s} (T_{vj} = 150^{\circ}\text{C})$ $R_{Gon} = 0,75\ \Omega$ | $T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$ | E_{on} | 12,0 20,0 22,5 | | | mJ mJ mJ |
| Abschaltverlustenergie pro Puls Turn-off energy loss per pulse | $I_C = 225\text{ A}, V_{CE} = 600\text{ V}, L_S = 35\text{ nH}$ $V_{GE} = \pm 15\text{ V}, du/dt = 3200\text{ V}/\mu\text{s} (T_{vj} = 150^{\circ}\text{C})$ $R_{Goff} = 0,75\ \Omega$ | $T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 150^{\circ}\text{C}$ | E_{off} | 18,5 28,5 31,0 | | | mJ mJ mJ |
| Kurzschlußverhalten SC data | $V_{GE} \leq 15\text{ V}, V_{CC} = 800\text{ V}$ $V_{CEmax} = V_{CES} - L_{SCE} \cdot di/dt$ $t_P \leq 10\ \mu\text{s}, T_{vj} = 150^{\circ}\text{C}$ | | I_{SC} | 900 | | | A |
| Wärmewiderstand, Chip bis Kühlkörper Thermal resistance, junction to heatsink | pro IGBT / per IGBT valid with IFX pre-applied thermal interface material | | R_{thJH} | | | 0,160 | K/W |
| Temperatur im Schaltbetrieb Temperature under switching conditions | | | $T_{vj\text{ op}}$ | -40 | | 150 | $^{\circ}\text{C}$ |

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